TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74LCX16374FT

Low-Voltage 16-Bit D-Type Flip-Flop with 5-V Tolerant Inputs and Outputs

The TC74LCX16374FT is a high-performance CMOS 16-bit D-type flip-flop. Designed for use in 2.5-V or 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

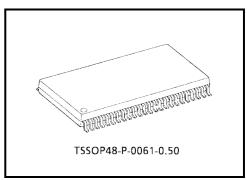
The device is designed for low-voltage (2.5-V or 3.3-V) V<sub>CC</sub> applications, but it could be used to interface to 5-V supply environment for both inputs and outputs.

This 16-bit D-type flip-flop is controlled by a clock input (CK) and an output enable input  $(\overline{OE})$  which are common to each byte. It can be used as two 8-bit flip-flops or one 16-bit flip-flop. When the  $\overline{OE}$  input is high, the outputs are in a high-impedance state.

All inputs are equipped with protection circuits against static discharge.

### Features

- Low-voltage operation:  $V_{CC} = 2.0$  to 3.6 V
- High-speed operation:  $t_{pd} = 6.2 \text{ ns} (max) (V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$
- Ouput current:  $|I_{OH}|/I_{OL} = 24 \text{ mA} (\text{min}) (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: ±500 mA
- Package: TSSOP (thin shrink small outline package)
- Power-down protection provided on all inputs and outputs



Weight: 0.25 g (typ.)

### Pin Assignment (top view)

			1	
10E	1	$\bigcirc$	48	1CK
1Q1	2		47	1D1
1Q2	3		46	1D2
GND	4		45	GND
1Q3	5		44	1D3
1Q4	6		43	1D4
V <sub>CC</sub>	7		42	V <sub>CC</sub>
1Q5	8		41	1D5
1Q6	9		40	1D6
GND	10		39	GND
1Q7	11		38	1D7
1Q8	12		37	1D8
2Q1	13		36	2D1
2Q2	14		35	2D2
GND	15		34	GND
2Q3	16		33	2D3
2Q4	17		32	2D4
V <sub>CC</sub>	18		31	V <sub>CC</sub>
2Q5	19		30	2D5
2Q6	20		29	2D6
GND	21		28	GND
2Q7	22		27	2D7
2Q8	23		26	2D8
2 <mark>0E</mark>	24		25	2CK
		L	J	

### IEC Logic Symbol

	[	1		
	1EN			
1CK <u>48</u>	⊳c1			
20E24	2EN			
2CK <u>25</u>	C2			
	L			
1D1 <u>47</u>	- 1D	1 🗸	2	- 1Q1
1D2 <u>46</u>		· •	3	- 1Q2
1D3 <u>44</u>			5	- 1Q3
$1D4 - \frac{43}{3}$			6	- 1Q4
1D5 <u>41</u>			8	- 1Q5
$1D6 - \frac{40}{1}$			9	- 1Q6
1D7 <u>38</u>			11	- 1Q7
1D8 <u>37</u>			12	- 1Q8
2D1 <u>36</u>	2D	2 🗸	13	- 2Q1
$2D2 - \frac{35}{35}$			14	- 2Q2
2D3 <u>33</u>			16	- 2Q3
2D0 <u>32</u>			17	- 2Q4
$2D_{-}^{2D_{-}^{-}}$			19	- 2Q5
2D5 2D6 <u>29</u>			20	- 2Q6
2D0 2D7 <u>27</u>			22	- 2Q7
2D7 2D8 <u>26</u>			23	- 2Q8
200				200

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### **Truth Table**

	Outputs		
1 <del>0E</del>	1CK	1D1-1D8	1Q1-1Q8
Н	Х	Х	Z
L		Х	Qn
L		L	L
L		Н	Н

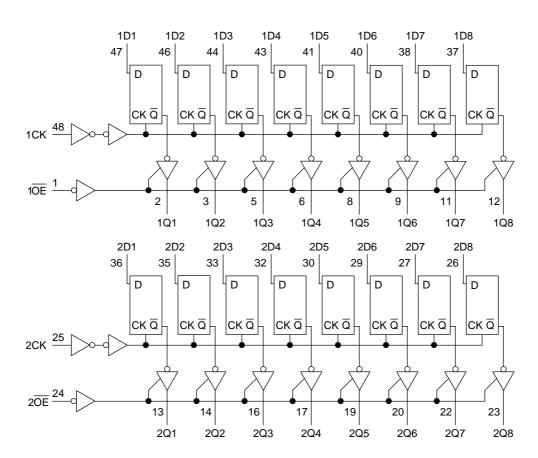
	Outputs		
2 <del>0E</del>	2CK	2D1-2D8	2Q1-2Q8
Н	Х	Х	Z
L		Х	Qn
L		L	L
L		Н	Н

X: Don't care

Z: High impedance

Qn: No change

### System Diagram



#### **Maximum Ratings**

Characteristics	Symbol	Rating	Unit
Power supply voltage	V <sub>CC</sub>	-0.5 to 6.0	V
Input voltage	V <sub>IN</sub>	-0.5 to 7.0	V
Output voltage		-0.5 to 7.0 (Note 1)	V
Output voltage	V <sub>OUT</sub>	$-0.5$ to $V_{\mbox{\scriptsize CC}}$ + 0.5 (Note 2)	v
Input diode current	I <sub>IK</sub>	-50	mA
Output diode current	I <sub>OK</sub>	±50 (Note 3)	mA
DC output current	IOUT	±50	mA
Power dissipation	PD	400	mW
DC V <sub>CC</sub> /ground current per supply pin	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Output in OFF state

Note 2: High or low state.  $I_{\mbox{OUT}}$  absolute maximum rating must be observed.

Note 3:  $V_{OUT}$  < GND,  $V_{OUT}$  >  $V_{CC}$ 

#### **Recommended Operating Conditions**

Characteristics	Symbol	Rating	Unit
Power supply voltage	V <sub>CC</sub>	2.0 to 3.6	V
Tower supply voltage	vcc	1.5 to 3.6 (Note 4)	v
Input voltage	V <sub>IN</sub>	0 to 5.5	V
Output voltage	Vout	0 to 5.5 (Note 5)	V
Output voltage	V001	0 to V <sub>CC</sub> (Note 6)	v
		±24 (Note 7)	
Output current	I <sub>OH</sub> /I <sub>OL</sub>	±12 (Note 8)	mA
		±8 (Note 9)	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 10 (Note 10)	ns/V

Note 4: Data retention only

Note 5: Output in OFF state

Note 6: High or low state

Note 7:  $V_{CC} = 3.0$  to 3.6 V

Note 8:  $V_{CC} = 2.7$  to 3.0 V

Note 9:  $V_{CC} = 2.3$  to 2.7 V

Note 10:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CC} = 3.0$  V

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### **Electrical Characteristics**

### DC Characteristics (Ta = -40 to $85^{\circ}$ C)

Characteristics		Symbol	Test Co	ondition		Min	Max	Unit
					V <sub>CC</sub> (V)			
	H-level	VIH	_	_	2.3 to 2.7	1.7	_	
Input voltage					2.7 to 3.6	2.0	—	V
	L-level	VIL	_	_	2.3 to 2.7		0.7	-
	LICVCI	۷IL			2.7 to 3.6	—	0.8	
				I <sub>OH</sub> = -100 μA	2.3 to 3.6	V <sub>CC</sub> - 0.2	_	
				$I_{OH} = -8 \text{ mA}$	2.3	1.8	_	
	H-level	Vон	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OH</sub> = -12 mA	2.7	2.2		
Output voltage				I <sub>OH</sub> = -18 mA	3.0	2.4		
			I <sub>OH</sub> = -24 mA	3.0	2.2		V	
		el V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	2.3 to 3.6	_	0.2	-
				I <sub>OL</sub> = 8 mA	2.3	_	0.6	
	L-level			I <sub>OL</sub> = 12 mA	2.7	_	0.4	
				I <sub>OL</sub> = 16 mA	3.0		0.4	
				I <sub>OL</sub> = 24 mA	3.0	_	0.55	
Input leakage current	•	I <sub>IN</sub>	$V_{IN} = 0$ to 5.5 V	V <sub>IN</sub> = 0 to 5.5 V		_	±5.0	μA
			$V_{IN} = V_{IH} \text{ or } V_{IL}$					
3-state output OFF state current		I <sub>OZ</sub>	V <sub>OUT</sub> = 0 to 5.5 V		2.3 to 3.6	—	±5.0	μA
Power-off leakage curr	ent	I <sub>OFF</sub>	$V_{IN}/V_{OUT} = 5.5 V$		0	_	10.0	μA
			V <sub>IN</sub> = V <sub>CC</sub> or GND		2.3 to 3.6	_	20.0	
Quiescent supply curre	ent	ICC	V <sub>IN</sub> /V <sub>OUT</sub> = 3.6 to 5.5 V		2.3 to 3.6	_	±20.0	μA
Increase in Icc per inpu	ut	∆lcc	V <sub>IH</sub> = V <sub>CC</sub> – 0.6 V		2.3 to 3.6	_	500	

AC Characteristics (Ta = -40 to 85°C)

Characteristics	Symbol	Symbol Test Condition					Max	Unit
Characteristics	Symbol			$V_{CC}(V)$	CL(pF)	Min	Ινίαλ	Onit
Maximum clock frequency				$\textbf{2.5}\pm\textbf{0.2}$	30		_	
	f <sub>max</sub>	Figure 1, Figure 2		2.7	50			MHz
				$\textbf{3.3}\pm\textbf{0.3}$	50	170		
Dropogation delay time	4			$\textbf{2.5}\pm\textbf{0.2}$	30	1.5	7.4	
Propagation delay time (CK-Q)	t <sub>pLH</sub>	Figure 1, Figure 2		2.7	50	1.5	6.5	ns
(CK-Q)	<sup>t</sup> pHL			$\textbf{3.3}\pm\textbf{0.3}$	50	1.5	6.2	
	<b>4</b>			$\textbf{2.5}\pm\textbf{0.2}$	30	1.5	7.9	
3-state output enable time	t <sub>pZL</sub>	Figure 1, Figure 3		2.7	50	1.5	6.3	ns
	<sup>t</sup> pZH			$\textbf{3.3}\pm\textbf{0.3}$	50	1.5	6.1	
	<b>.</b>	Figure 1, Figure 3		$\textbf{2.5}\pm\textbf{0.2}$	30	1.5	7.2	ns
3-state output disable time	t <sub>pLZ</sub>			2.7	50	1.5	6.2	
	<sup>t</sup> pHZ		$\textbf{3.3}\pm\textbf{0.3}$	50	1.5	6.0		
		$t_{W}$ (H) $t_{W}$ (L) Figure 1, Figure 2		$\textbf{2.5}\pm\textbf{0.2}$	30	3.5		ns
Minimum pulse width (CK)				2.7	50	3.0	_	
	۲ <sub>W</sub> (۲)			$\textbf{3.3}\pm\textbf{0.3}$	50	3.0	_	
				$\textbf{2.5}\pm\textbf{0.2}$	30	3.0	_	
Minimum setup time	ts	Figure 1, Figure 2		2.7	50	2.5		ns
				$\textbf{3.3}\pm\textbf{0.3}$	50	2.5		
				$\textbf{2.5}\pm\textbf{0.2}$	30	2.0		
Minimum hold time	t <sub>h</sub>	Figure 1, Figure 2		2.7	50	1.5		ns
				$\textbf{3.3}\pm\textbf{0.3}$	50	1.5		
	<b>+</b>			$2.5\pm0.2$	30			
Output to output skew	t <sub>osLH</sub>	(Nc	ote 11)	2.7	50			ns
	t <sub>osHL</sub>		Γ	$\textbf{3.3}\pm\textbf{0.3}$	50	_	1.0	

Note 11: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)$ 

# Dynamic Switching Characteristics (Ta = 25°C, input: $t_r = t_f = 2.5$ ns, $R_L = 500 \Omega$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum	VOLP	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}, C_L = 30 \text{pF}$	2.5	0.6	V
dynamic V <sub>OL</sub>	VOLP	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}, C_L = 50 \text{pF}$	3.3	0.8	v
Quiet output minimum	V <sub>OLV</sub>	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}, C_L = 30 \text{pF}$	2.5	0.6	V
dynamic V <sub>OL</sub>		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}, C_L = 50 \text{pF}$	3.3	0.8	v

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### **Capacitive Characteristics (Ta = 25°C)**

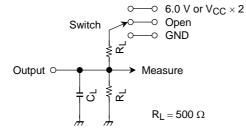
Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>			3.3	7	pF
Output capacitance	C <sub>OUT</sub>			3.3	8	pF
Power dissipation capacitance	C <sub>PD</sub>	$f_{IN} = 10 \text{ MHz}$ (Not	te 12)	3.3	25	pF

Note 12: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16$  (per bit)

### **AC Test Circuit**

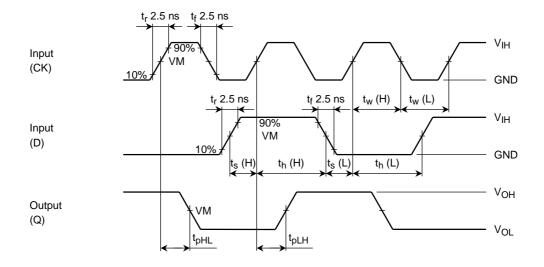


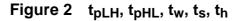
Parameter	Switch		
t <sub>pLH</sub> , t <sub>pHL</sub>	Open		
t <sub>pLZ</sub> , t <sub>pZL</sub>	$\begin{array}{ll} 6.0 \ V & @ \ V_{CC} = 3.3 \pm 0.3 \ V \\ V_{CC} \times 2 & @ \ V_{CC} = 2.5 \pm 0.2 \ V \end{array}$		
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND		

Figure 1

### AC Waveform

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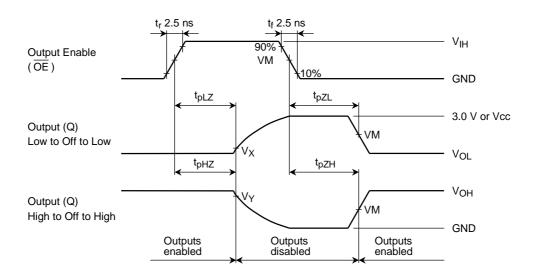


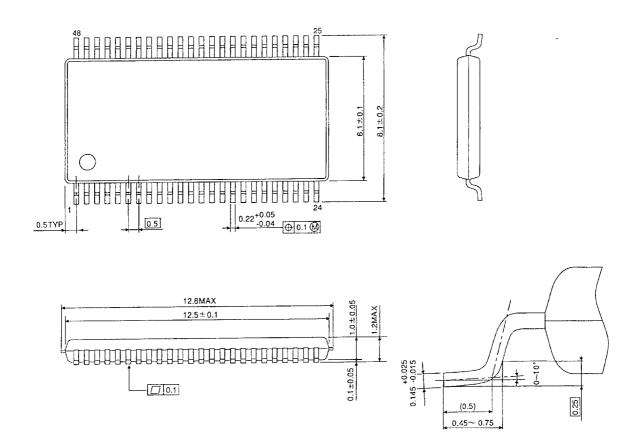
Figure 3  $t_{pLZ}$ ,  $t_{pHZ}$ ,  $t_{pZL}$ ,  $t_{pZH}$ 

Symbol			
Symbol	$3.3\pm0.3~\text{V}$	2.7 V	$2.5\pm0.2\;V$
V <sub>IH</sub>	2.7 V	2.7 V	V <sub>CC</sub>
VM	1.5 V	1.5 V	V <sub>CC</sub> /2
VX	$V_{OL}$ + 0.3 V	$V_{OL}$ + 0.3 V	V <sub>OL</sub> + 0.15 V
VY	V <sub>OH</sub> – 0.3 V	V <sub>OH</sub> – 0.3 V	V <sub>OH</sub> – 0.15 V

### **Package Dimensions**

TSSOP48-P-0061-0.50

Unit : mm



Weight: 0.25 g (typ.)

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